IN THE CLAIMS:

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- 1. (Currently Amended) A positive photosensitive composition comprising:
- (A) an alkali soluble organic high molecular substance having a phenolic hydroxyl group,
- (B) a photo-thermal conversion material that absorbs infrared rays from an image exposure light source and converts it to heat,
- (C) at least one resin selected from the group consisting of[[;]]: (1) vinylpyrrolidone/vinyl acetate copolymer, (2) vinylpyrrolidone/dimethyl- aminoethyl methacrylate copolymer, (3) vinylpyrrolidone/vinyl caprolactam/ dimethylaminoethyl methacrylate copolymer, (4) polyvinyl acetate, (5) polyvinyl butyral, (6) polyvinyl formal, (7) styrene/maleic acid copolymer, (8) terpene phenol resin, (9) alkylphenol resin, (10) melamine/formaldehyde resin, and (11) ketone resin, and
 - (D) a dissolution inhibitor.
- 2. (Original) The positive photosensitive composition according to claim 1, wherein the dissolution inhibitor (D) is a compound represented by the following chemical formula (1).

_____3. (Currently Amended) The positive photosensitive composition according to claim 1 or 2, wherein the photo-thermal conversion material (B) is a compound represented by the following formula (2).

$$\begin{bmatrix} R_1 & H_3C & CH_3 & CI & H_3C & CH_3 & R^4 \\ R^2 & CH & CH & CH & CH & CH & R^5 \end{bmatrix} \xrightarrow{R^4} \cdots (2)$$

wherein each of "R1" to "R6" independently represents a hydrogen atom, an alkyl group having 1 to 3 carbon atoms, or an alkoxyl group having 1 to 3 carbon atoms, and "X" represents a halogen atom, ClO₄, BF₄, p-CH₃C₆H₄SO₃, or PF₆.

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4. (Currently Amended) The positive photosensitive composition according to claim 1 or 2, wherein the photo-thermal conversion material (B) is a compound represented by the

following formula (3).

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wherein each of " R^7 " ~" R^{10} " independently represents a hydrogen atom, a methoxyl group, $N(CH_3)_2, \text{ or } N(C_2H_5)_2, \text{ and "Y" represents } C_4H_9-B(C_6H_5)_3, \text{ p-CH}_3C_6H_4SO_3, \text{ or } CF_3SO_3.$

5. (Currently Amended) A photofabrication method <u>comprising</u>:

exposing using the positive photosensitive composition according to any of claims 1 to 4 as defined in claim 1 to a laser beam having a wavelength of from 700 to 1,100 nm. to form a positive image.

- 6. (Original) The photo fabrication method according to claim 5, which is applied to production of a printing plate, an electronic component and a precision equipment component.
 - 7. (Currently Amended) A plate-making method comprising:

exposing using the positive photosensitive composition according to any of claims 1 to 4 as defined in claim 1 to a laser beam having a wavelength of from 700 to 1,100 nm. to form a positive image.

______8. (New) The positive photosensitive composition according to claim 2, wherein the photo-thermal conversion material (B) is a compound represented by the following formula (2).

wherein each of "R1" to "R6" independently represents a hydrogen atom, an alkyl group having 1 to 3 carbon atoms, or an alkoxyl group having 1 to 3 carbon atoms, and "X" represents a halogen atom, ClO_4 , BF_{4} , $p-CH_3C_6H_4SO_3$, or PF_6 .

_____9. (New) The positive photosensitive composition according to claim 2, wherein the photo-thermal conversion material (B) is a compound represented by the following formula (3).

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wherein each of " R^7 " ~" R^{10} " independently represents a hydrogen atom, a methoxyl group, $N(CH_3)_2$, or $N(C_2H_5)_2$, and "Y" represents C_4H_9 - $B(C_6H_5)_3$, p- $CH_3C_6H_4SO_3$, or CF_3SO_3 .

10. (New) A photofabrication method comprising:

exposing the positive photosensitive composition as defined in claim 2 to a laser beam having a wavelength of from 700 to 1,100 nm. to form a positive image.

11. (New) The photofabrication method according to claim 10, which is applied to production of a printing plate, an electronic component and a precision equipment component.

12. (New) A plate-making method comprising:

exposing the positive photosensitive composition as defined in claim 2 to a laser beam having a wavelength of from 700 to 1,100 nm. to form a positive image.